L Number	Hits	Search Text	DB	Time stamp
1	36	(("3612165") or ("3956936") or ("3966500")	USPAT	2004/08/18
		or ("4030015") or ("4113391") or ("4443117")		14:47
		or ("4475823") or ("4486652") or ("4627744")		
		or ("4903754") or ("5226472") or ("5252807")		
		or ("5291514") or ("5410162") or ("5411076")	1	
		or ("5484011") or ("5567267") or ("5584971")		
		or ("5595241") or ("5802856") or ("5892207")		
		or ("6326647") or ("6353209") or ("6353210")		
		or ("6414276") or ("6423947") or ("6433314")		
		or ("6471913") or ("6472643") or ("6508920")		
		or ("6529686") or ("6537422") or ("6544338")		
		or ("6563686") or ("6580059") or		
		("6639189")).PN.		
2	2067	((219/390 or 219/405 or 219/411 or 392/416	USPAT	2004/08/18
		or 392/418 or 118/724 or 118/725 or 118/50.1	001741	14:50
		or 118/728-729).ccls. and (substrate\$1 or		1-1.00
		wafer\$1)) and (heat\$3 and cool\$3)		
3	416	(((219/390 or 219/405 or 219/411 or 392/416	USPAT	2004/08/18
		or 392/418 or 118/724 or 118/725 or 118/50.1	JOI AT	14:51
		or 118/728-729).ccls. and (substrate\$1 or		14.51
		wafer\$1)) and (heat\$3 and cool\$3) ) and		
		((first and second) near8 temperature\$1)		
4	279	((((219/390 or 219/405 or 219/411 or 392/416	USPAT	2004/08/18
- <b>-</b>	2,3	or 392/418 or 118/724 or 118/725 or 118/50.1	USPAI	14:52
		or 118/728-729).ccls. and (substrate\$1 or		14:52
		wafer\$1)) and (heat\$3 and cool\$3) ) and		
		((first and second) near8 temperature\$1))		
		and (gas\$2 and pressur\$4)		
_	83	(((((219/390 or 219/405 or 219/411 or 392/416	HEDAT	2004/09/49
5	03	or 392/418 or 118/724 or 118/725 or 118/50.1	USPAT	2004/08/18
				14:52
		or 118/728-729).ccls. and (substrate\$1 or		
		wafer\$1)) and (heat\$3 and cool\$3) ) and		
		((first and second) near8 temperature\$1))		
		and (gas\$2 and pressur\$4)) and ((heat\$3 and		
	_	cool\$3) near8 plate\$1)		
•	3	(("5113929") or ("5775416") or	USPAT	2004/08/18
	2424	("5881208")).PN.		12:56
•	3494	(219/390 or 219/405 or 219/411 or 392/416 or	USPAT	2004/08/18
		392/418 or 118/724 or 118/725 or 118/50.1 or		14:50
		118/728-729).ccls. and (substrate\$1 or		
		wafer\$1)		
,	2067	((219/390 or 219/405 or 219/411 or 392/416	USPAT	2004/08/18
		or 392/418 or 118/724 or 118/725 or 118/50.1		14:50
		or 118/728-729).ccls. and (substrate\$1 or		
		wafer\$1)) and (heat\$3 and cool\$3)		
-	383	(((219/390 or 219/405 or 219/411 or 392/416	USPAT	2004/08/18
		or 392/418 or 118/724 or 118/725 or 118/50.1		13:03
		or 118/728-729).ccls. and (substrate\$1 or		
		wafer\$1)) and (heat\$3 and cool\$3)) and		
		((heat\$3 and cool\$3) near8 plate\$1)		

•	268	((((219/390 or 219/405 or 219/411 or 392/416	USPAT	2004/08/18
		or 392/418 or 118/724 or 118/725 or 118/50.1		14:39
		or 118/728-729).ccls. and (substrate\$1 or		
		wafer\$1)) and (heat\$3 and cool\$3)) and		
		((heat\$3 and cool\$3) near8 plate\$1)) and		
•		((move or moving or moveable or lift\$3 or		
		raise or raising or lower\$3) near10 plate\$1)		